

Response Under 37 C.F.R. § 1.116 Expedited Procedure Examining Group 2800

PATENT ATTORNEY DOCKET NO. 053933-5046

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

| In re Application of: |) | |
|--|-----------------|-----------------|
| Jong-Jin LEE et al. |) Confirma | ation No.: 1723 |
| Application No.: 10/609,499 |) Group A | rt Unit: 2814 |
| Filed: July 1, 2003 |) Examine | r: N. Ha |
| For: PACKAGE SUBSTRATE MANUFACTURED USING |)) Mail Sto | p AF |
| ELECTROLYTIC LEADLESS |) | |
| PLATING PROCESS, AND METHOD |) | |
| FOR MANUFACTURING THE SAME |) | |

Commissioner for Patents
U.S. Patent and Trademark Office
Mail Stop AF
Alexandria, VA 22314

Sir:

AMENDMENT UNDER 37 C.F.R. § 1.116

In response to the Final Office Action dated May 25, 2005, the period for response to which extends through August 25, 2005, entry of the following amendment and remarks is respectfully requested to place the application in clear condition for allowance or, alternatively, in better form for appeal.